INTERNATIONAL STANDARD

ISO 9455-13

Second edition 2017-08

Soft soldering fluxes — Test methods —

Part 13: **Determination of flux spattering**

Flux de brasage tendre — Méthodes d'essai — Partie 13: Détermination des projections de flux

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Foreword

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This document was prepared by Technical Committee ISO/TC 44, *Welding and allied processes*, Subcommittee SC 12, *Soldering materials*.

This second edition cancels and replaces the first edition (ISO 9455-13:1996), which has been technically revised. [SO 9455-[3:20]7

The main changes to the previous version are:

- solder designations have been updated according to ISO 9453;
- the test report has been updated;
- editorial revisions have been made.

A list of all parts in the ISO 9455 series can be found on the ISO website.

Requests for official interpretations of any aspect of this document should be directed to the Secretariat of ISO/TC 44/SC 12 via your national standards body. A complete listing of these bodies can be found at www.iso.org.